



Features

Low On-Resistance ESD Protected Gate

Mechanical Data

Method 208 (e3)

Case: SC59

**12V N-CHANNEL ENHANCEMENT MODE MOSFET** 

Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2) Halogen and Antimony Free. "Green" Device (Note 3) Qualified to AEC-Q101 Standards for High Reliability

Case Material - Molded Plastic. UL Flammability Rating 94V-0

Terminals: Finish - Matte Tin Solderable per MIL-STD-202,

Moisture Sensitivity: Level 1 per J-STD-020

Terminal Connections: See Diagram Weight: 0.014 grams (approximate)

#### **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> MAX	Ι <sub>D</sub> T <sub>A</sub> = +25°C
	10mΩ @ V <sub>GS</sub> = 4.5V	9.3A
	12mΩ @ V <sub>GS</sub> = 2.5V	8.5A
12V	14mΩ @ V <sub>GS</sub> = 1.8V	7.9A
	18mΩ @ V <sub>GS</sub> = 1.5V	6.9A
	41mΩ @ V <sub>GS</sub> = 1.2V	4.6A

#### Description

This new generation MOSFET has been designed to minimize the onstate resistance ( $R_{DS(ON)}$ ) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

### Applications

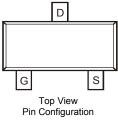
- Load Switch
- DC-DC Converters
- Power Management Functions

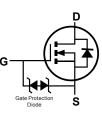




SC59

Top View





Equivalent Circuit

### Ordering Information (Note 4)

Part Number	Case	Packaging
DMN1019USN-7	SC59	3,000/Tape & Reel
DMN1019USN-13	SC59	10,000/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

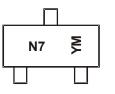
2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

### **Marking Information**

Notes:



N7 = Product Type Marking Code YM = Date Code Marking Y = Year ex: A = 2013 M = Month ex: 9 = September

Date Code Key											<u>.</u>	
Year	2013		2014	2015		2016	2017		2018	2019	)	2020
Code	А		В	С		D	E		F	G		Н
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units			
Drain-Source Voltage		V <sub>DSS</sub>	12	V		
Gate-Source Voltage	V <sub>GSS</sub>	±8	V			
Continuous Drain Current (Mate $C$ )/ $-4.5$ /	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	Ι <sub>D</sub>	9.3 7.4	А	
Continuous Drain Current (Note 6) $V_{GS}$ = 4.5V	t<10s	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	11 8.8	А	
Pulsed Drain Current (10µs pulse, duty cycle = 1%)	I <sub>DM</sub>	70	А			
Maximum Body Diode Forward Current (Note 6)	Is	2	A			

## **Thermal Characteristics**

NEW PRODUCT

Characteristic		Symbol	Value	Units	
Tatal Dawar Dissinction (Nata 5)	T <sub>A</sub> = +25°C	D	0.68	W	
Total Power Dissipation (Note 5)	T <sub>A</sub> = +70°C	PD	0.4		
Thermal Desistance Junction to Ambient (Note 5)	Steady state	D	160	°C/W	
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	R <sub>0JA</sub>	115	°C/W	
Tatal Dawar Dissinction (Nata 6)	T <sub>A</sub> = +25°C	D	1.2	W	
Total Power Dissipation (Note 6)	T <sub>A</sub> = +70°C	PD	0.83		
Thermal Registence, Junction to Ambient (Note 6)	Steady state	Р	96	°C/W	
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	68	°C/W	
Thermal Resistance, Junction to Case (Note 6)	R <sub>θJC</sub>	18	°C/W		
Operating and Storage Temperature Range	T <sub>J.</sub> T <sub>STG</sub>	-55 to +150	°C		

#### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

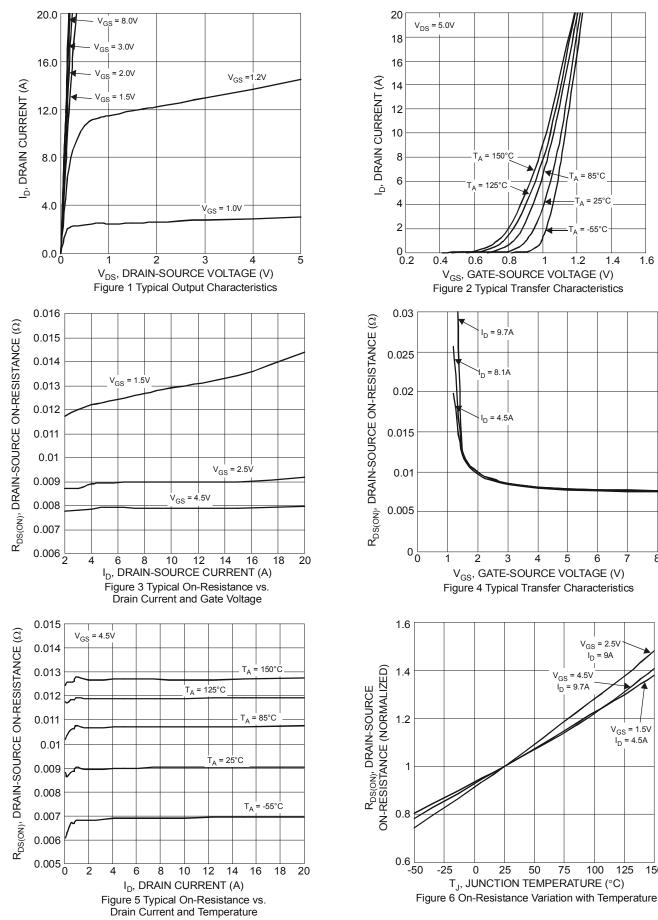
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)						-	
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	12	_	_	V	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250µA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>		_	1	μA	V <sub>DS</sub> =12V, V <sub>GS</sub> = 0V	
Gate-Body Leakage	I <sub>GSS</sub>	_	_	±2	μA	$V_{GS} = \pm 8V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V <sub>GS(th)</sub>	0.35	0.53	0.8	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
		—	7	10		V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 9.7A	
		—	8	12		V <sub>GS</sub> = 2.5V, I <sub>D</sub> = 9A	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	—	10	14	mΩ	V <sub>GS</sub> = 1.8V, I <sub>D</sub> = 8.1A	
	. ,		14	18		V <sub>GS</sub> = 1.5V, I <sub>D</sub> = 4.5A	
		_	28	41		V <sub>GS</sub> = 1.2V, I <sub>D</sub> = 2.4A	
Forward Transfer Admittance	IY <sub>fs</sub> I	_	28	_	S	V <sub>DS</sub> = 4V, I <sub>D</sub> = 9.7A	
Diode Forward Voltage	V <sub>SD</sub>		0.8	1.2	V	$V_{GS} = 0V, I_{S} = 10A$	
DYNAMIC CHARACTERISTICS (Note 8)	<u> </u>		•				
Input Capacitance	C <sub>iss</sub>	_	2426	_	pF		
Output Capacitance	C <sub>oss</sub>	_	396	—	pF	─V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V, −f = 1MHz	
Reverse Transfer Capacitance	C <sub>rss</sub>	_	375	_	pF		
Gate Resistance	Rq		1.1	_	Ω	$V_{DS}$ = 0V, $V_{GS}$ = 0V, f = 1MHz	
Total Gate Charge (V <sub>GS</sub> = 8V)	Qg	_	50.6	_			
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qq		27.3	_			
Gate-Source Charge	Q <sub>gs</sub>	_	3.4	_	nC	$V_{DS} = 4V$ , $I_D = 10A$	
Gate-Drain Charge	Q <sub>gd</sub>		5.2	—			
Turn-On Delay Time	t <sub>D(ON)</sub>	_	7.6	_	ns		
Turn-Off Delay Time	t <sub>D(OFF)</sub>		22.2	—	ns	V <sub>DD</sub> = 4V, V <sub>GEN</sub> = 5V, I <sub>D</sub> = 10A,	
Turn-On Rise Time	tr	—	57.6	_	ns	$R_G = 1\Omega, R_L = 0.4\Omega$	
Turn-Off Fall Time	t <sub>f</sub>	_	16.8	_	ns		

Notes:

5. Device mounted on FR-4 PCB with minimum recommended pad layout, single sided. The power dissipation  $P_D$  is based on t<10s  $R_{BJA}$ . 6. Device mounted on 1" x 1" FR-4 PCB with high coverage 2 oz. Copper, single sided. The power dissipation  $P_D$  is based on t<10s  $R_{BJA}$ . 7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to production testing.



### DMN1019USN



NEW PRODUCT

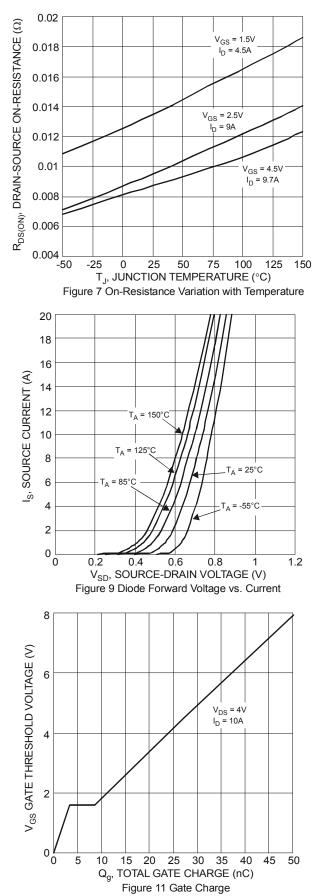
DMN1019USN Document number: DS36999 Rev. 2 - 2 150

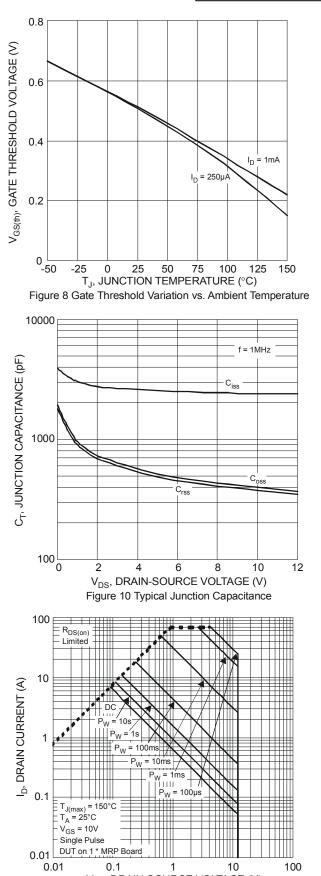
8

<sup>3</sup> of 6 Downloaded From Oneyac.com



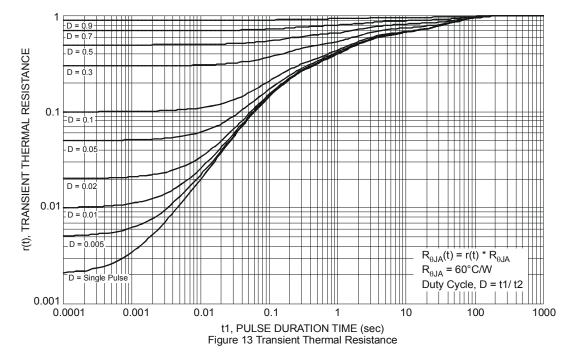
### DMN1019USN





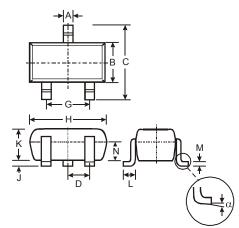
V<sub>DS</sub>, DRAIN-SOURCE VOLTAGE (V) Figure 12 SOA, Safe Operation Area





### Package Outline Dimensions

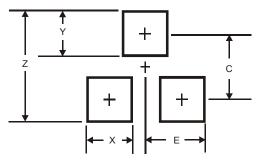
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SC59							
Dim	Min	Max	Тур				
Α	0.35	0.50	0.38				
в	1.50	1.70	1.60				
С	2.70	3.00	2.80				
D	-	-	0.95				
G	-	-	1.90				
н	2.90	3.10	3.00				
J	0.013	0.10	0.05				
к	1.00	1.30	1.10				
L	0.35	0.55	0.40				
М	0.10	0.20	0.15				
Ν	0.70	0.80	0.75				
α	0°	8°	-				
All Dimensions in mm							

## Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	3.4
Х	0.8
Y	1.0
С	2.4
E	1.35

DMN1019USN Document number: DS36999 Rev. 2 - 2



#### IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

#### LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

- A. Life support devices or systems are devices or systems which:
  - 1. are intended to implant into the body, or
  - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2014, Diodes Incorporated

www.diodes.com

单击下面可查看定价,库存,交付和生命周期等信息

>>Diodes Incorporated(达迩科技(美台))